

Characterization of Contact and Bulk Thermal Resistance of Laminations for Electric Machines



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**J. Emily Cousineau, Kevin Bennion,
Douglas DeVoto, Sreekant Narumanchi**

Outline

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- **Results**
 - Bulk thermal conductivity
 - Contact resistance between laminations
 - Effective through-stack thermal conductivity
 - In-plane thermal conductivity
- **Conclusions**

Background

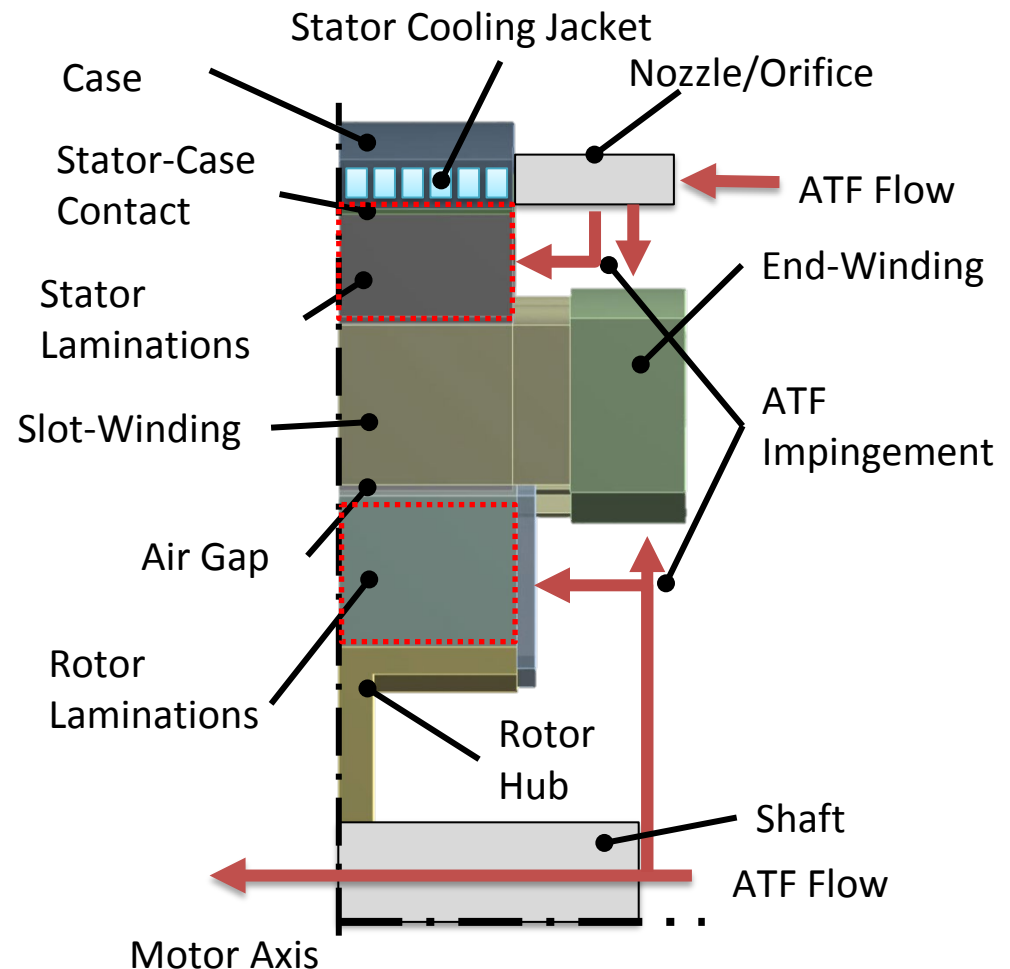
Problem

- Extracting heat from within the motor to protect motor and enable high power density

Laminations make up a large portion of the stator and rotor

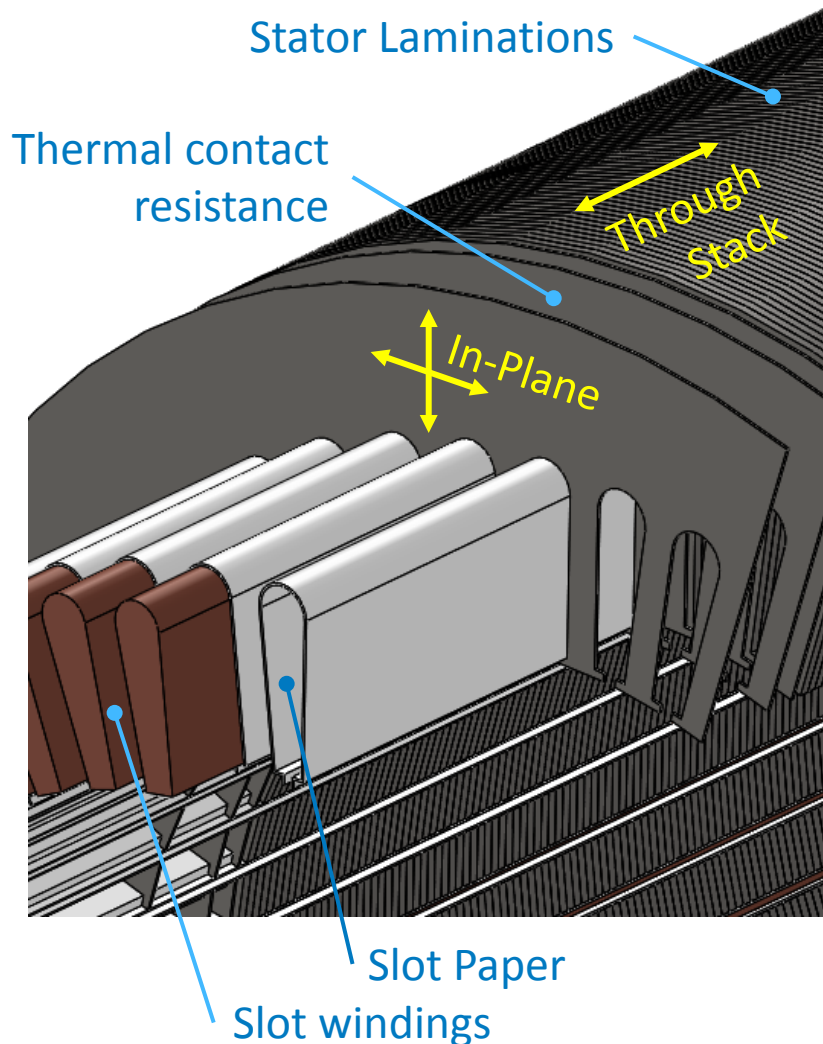
- Significant portion of thermal pathway to remove heat from motor
- Greater knowledge of factors affecting thermal conductivity can improve motor design models
- Currently a lack of public literature

Motor Cooling Section View



ATF: Automatic Transmission Fluid

Overview



- Transversely isotropic thermal properties
 - Bulk properties in-plane
 - Effective properties through-stack

Approach

- Lamination bulk thermal conductivity measured with xenon flash equipment
- Through-stack thermal conductivity measured on test apparatus built in accordance with ASTM D5470-12 steady state technique
- Tested at multiple sample pressures

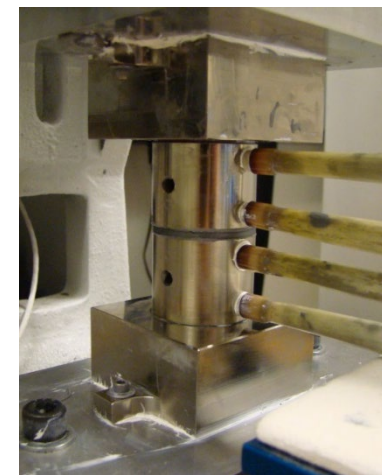
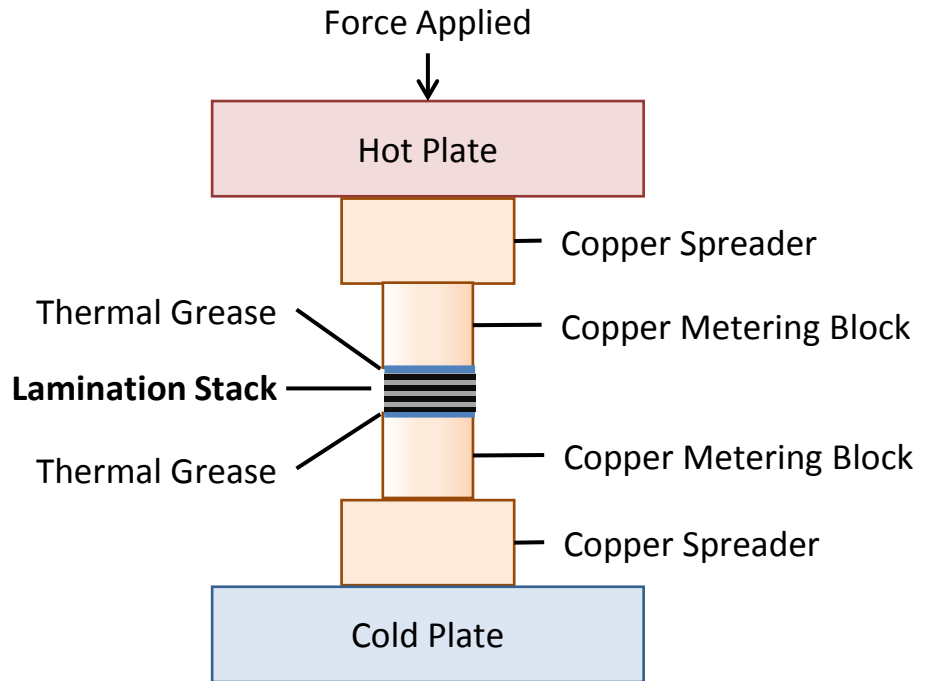
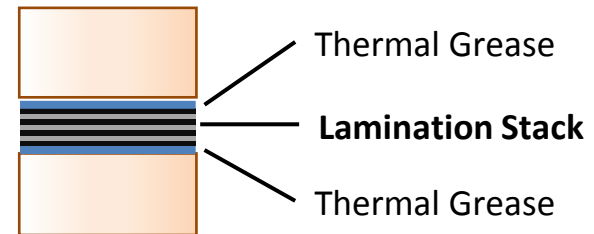
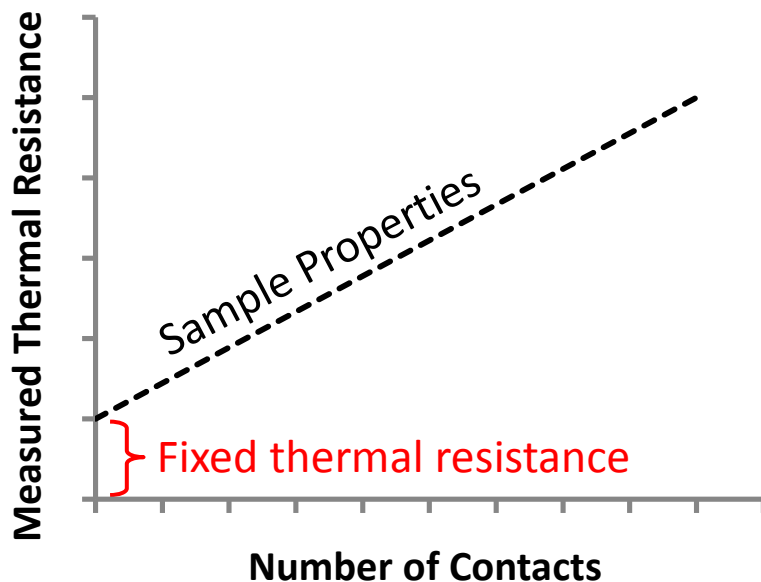


Photo Credit: Emily Cousineau

Approach

- Experiments performed on multiple stack heights
- Slope gives stack resistance as a function of number of laminations and contacts
- Eliminates fixed thermal resistance such as grease



$$R_{th} = \underbrace{(R_C + R_L)N_C}_{\text{slope}} + \underbrace{R_L + 2R_G}_{\text{Intercept (fixed values)}}$$

R_{th} = thermal resistance

R_C = thermal contact resistance

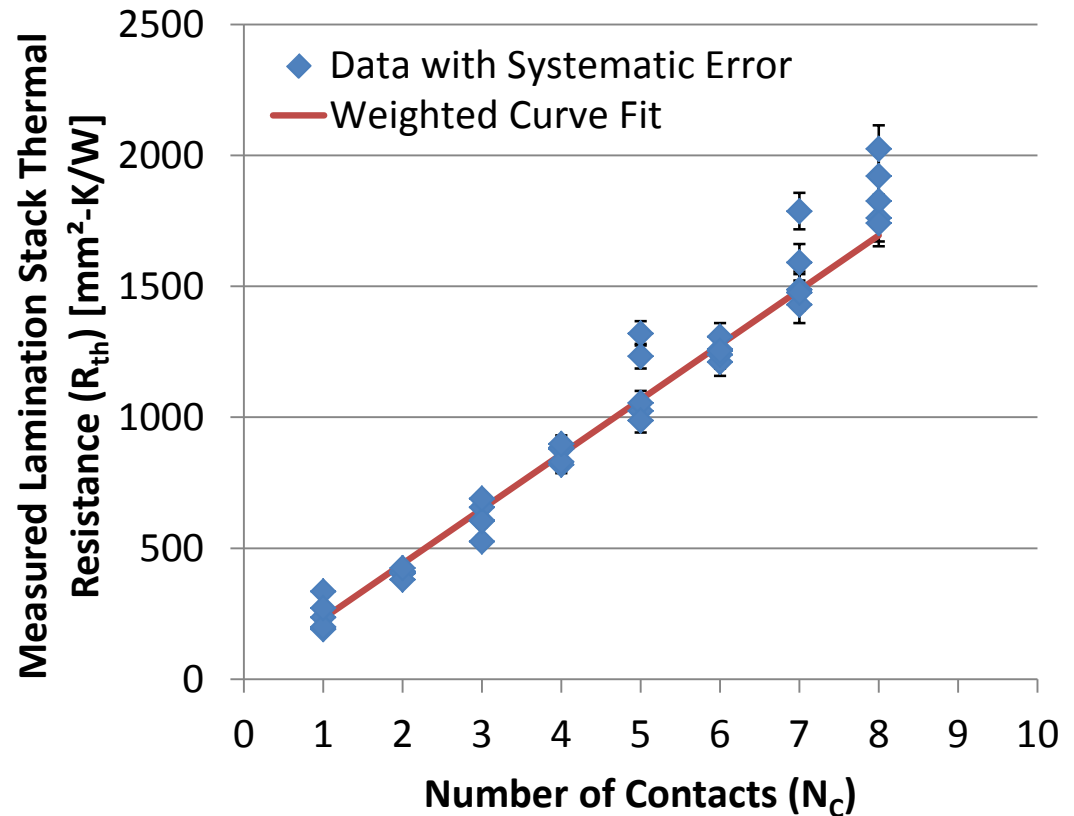
R_L = thermal resistance of one lamination

R_G = thermal resistance of grease layer

N_C = number of contacts

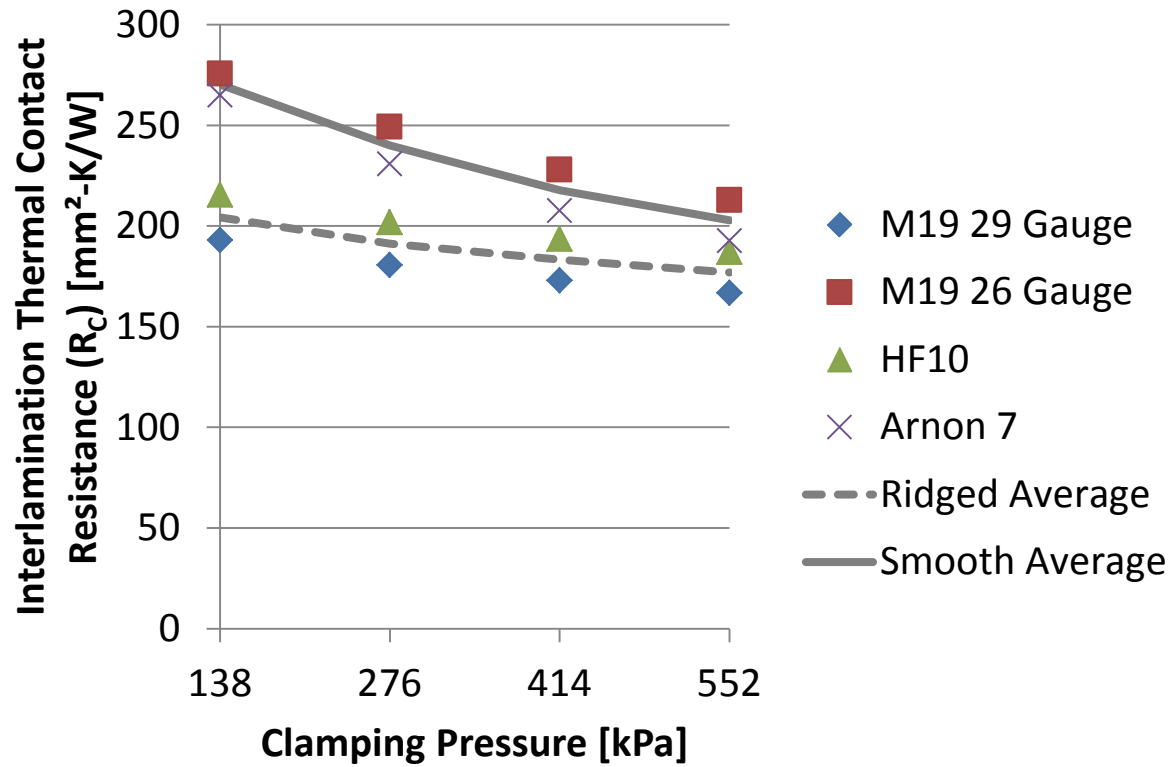
Results

- Lamination bulk thermal conductivity measured to be 20-23 W/m-K for tested materials
- 5 repetitions at each stack height
- Curve fit weighted on systematic error (error bars)



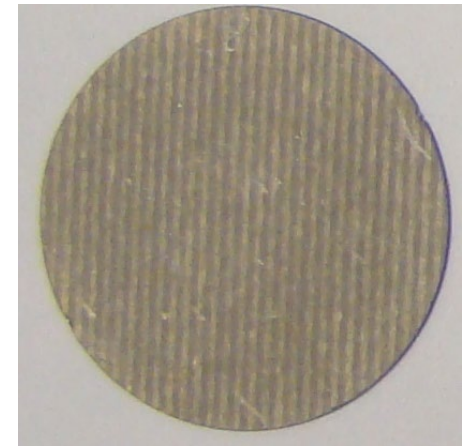
Full technical report available at: www.nrel.gov/publications/

Thermal Contact Resistance

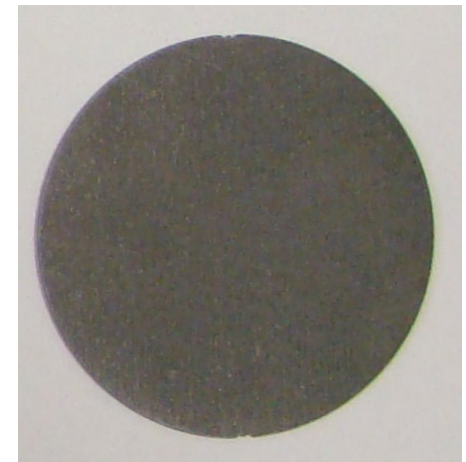


$$R_c = m - \frac{t}{k_L}$$

R_c = Interlamination thermal contact resistance
 m = slope of curve fit
 t = thickness of one lamination
 k_L = bulk thermal conductivity



Ridged

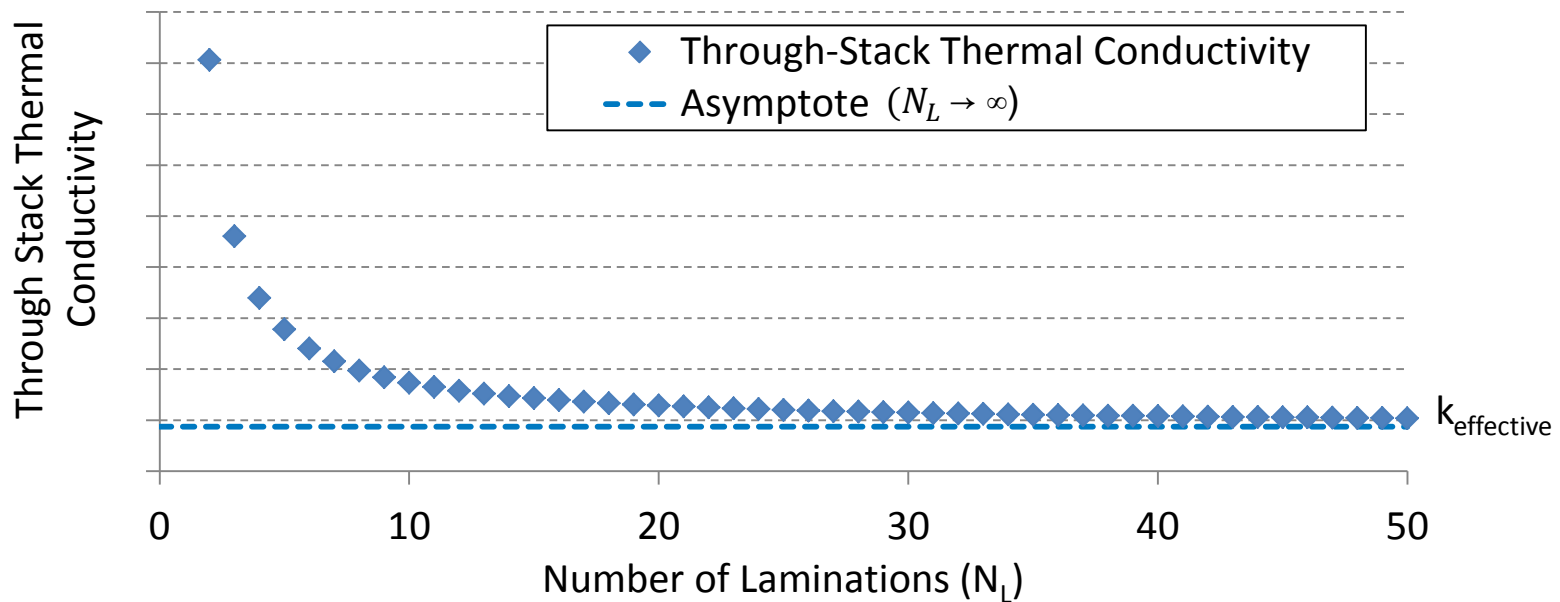


Smooth

Photo Credit: Emily Cousineau

Effective Through-Stack Thermal Conductivity

- Short length inhomogeneity
- Effective through stack thermal conductivity approaches an asymptote between 30 and 50 laminations
- Typical motors have several hundred laminations



$$k = \frac{\text{Total Thickness}}{\text{Total Resistance}} = \frac{t \cdot N_L}{R_C N_C + R_L N_L}$$

$$\lim_{N_C \rightarrow N_L} k = \frac{t}{R_C + R_L} = k_{\text{effective}}$$

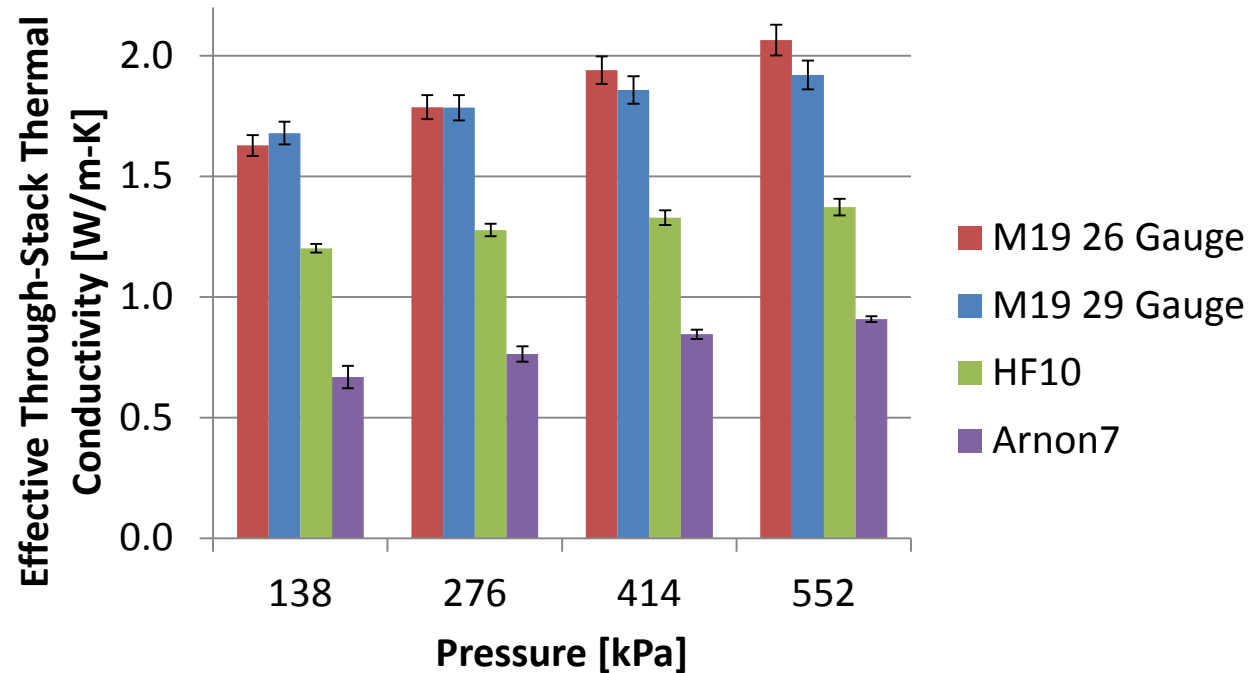
k = thermal conductivity
 t = thickness of one lamination

N_C = number of contacts
 N_L = number of laminations

R_C = thermal contact resistance
 R_L = thermal resistance of one lamination

Effective Through-Stack Thermal Conductivity

- Thinner laminations have more contacts per unit length
- Higher pressure lowers contact resistance
- Error bars represent 95% confidence interval



$$k_{effective} = \frac{t}{R_C + R_L}$$

$k_{effective}$ = effective thermal conductivity
 t = thickness of one lamination

R_C = thermal contact resistance
 R_L = thermal resistance of one lamination

In-Plane Thermal Conductivity

- In-plane thermal conductivity measured on test apparatus used to measure through-stack
- In-plane thermal conductivity measured to be the same as bulk
 - Effect of splitting into laminations negligible
- Confirms a basic area weighted average formula for thermal conductivity

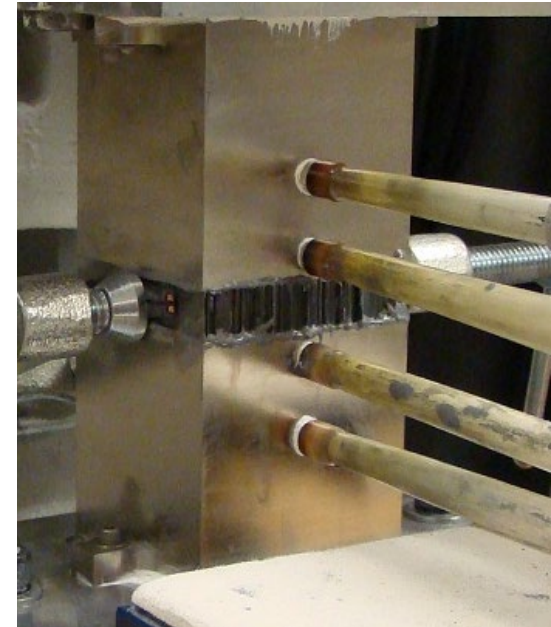
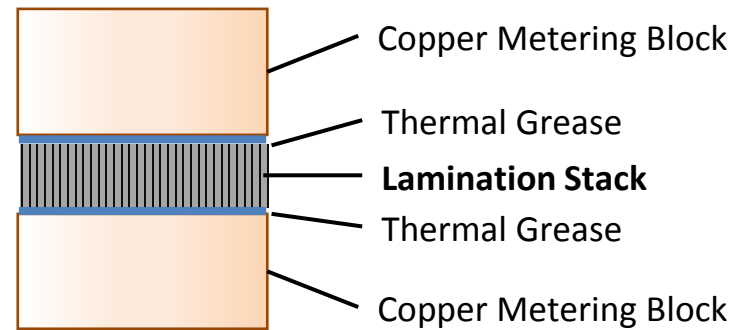


Photo Credit: Emily Cousineau

Samples provided by Oak Ridge National Laboratory

Conclusions

- For this class of materials and pressures tested:
 - Lamination-to-lamination thermal contact resistance measured to be 170 to 280 mm²-K/W
 - Reduces with pressure
 - Affected by surface topography
 - Effective through stack thermal conductivity measured to be between 0.7 to 2.1 W/m-K
 - Strongly impacted by lamination thickness and contact resistance
 - Lamination bulk thermal conductivity measured to be 20-23 W/m-K for tested materials
 - In-plane thermal conductivity is the same as the bulk material properties

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For more information, contact:

Emily Cousineau
Emily.Cousineau@nrel.gov
Phone: (303)-275-4031

Team Members:

Kevin Bennion (NREL)
Douglas DeVoto (NREL)
Charlie King (NREL)
Sreekant Narumanchi (NREL)